

# TLP3106

## 1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Instruments
- Factory Automation (FA)
- Amusement Equipment

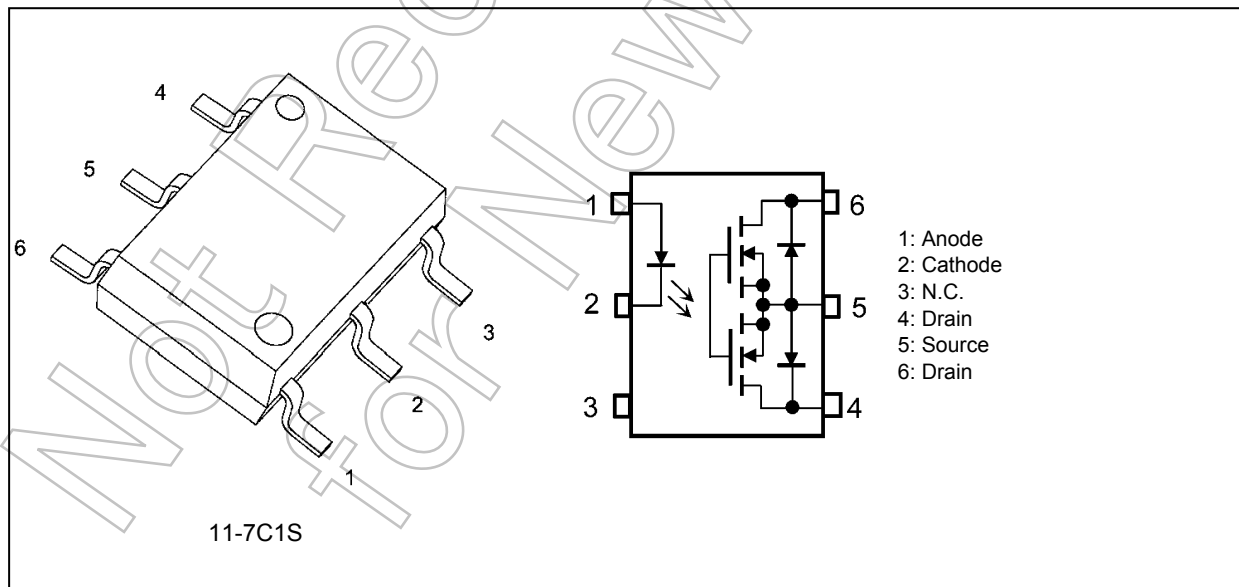
## 2. General

The TLP3106 photorelay consists of a photo MOSFET optically coupled to an infrared LED. It is housed in a 2.54SOP6 package. The low ON-state resistance and the high permissible ON-state current of the TLP3106 make it suitable for power line control applications.

## 3. Features

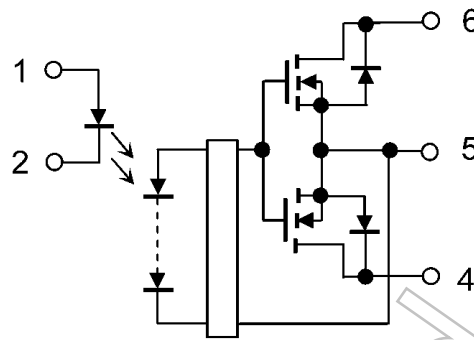
- (1) Normally opened (1-Form-A)
- (2) OFF-state output terminal voltage: 30 V (min)
- (3) Trigger LED current: 3 mA (max)
- (4) ON-state current: 4.0 A (max) (A connection)
- (5) ON-state resistance: 40 mΩ (max) (A connection)
- (6) Isolation voltage: 1500 Vrms (min)
- (7) Safety standards
  - UL-recognized: UL 1577, File No.E67349
  - cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

## 4. Packaging and Pin Assignment



Start of commercial production  
2015-05

## 5. Internal Circuit



## 6. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$ )

	Characteristics	Symbol	Note	Rating	Unit
LED	Input forward current	$I_F$		30	mA
	Input forward current derating ( $T_a \geq 25\text{ }^\circ\text{C}$ )	$\Delta I_F / \Delta T_a$		-0.3	mA/ $^\circ\text{C}$
	Input forward current (pulsed) (100 $\mu\text{s}$ pulse, 100 pps)	$I_{FP}$		1	A
	Input reverse voltage	$V_R$		5	V
	Input power dissipation	$P_D$		50	mW
	Input power dissipation derating ( $T_a \geq 25\text{ }^\circ\text{C}$ )	$\Delta P_D / \Delta T_a$		-0.5	mW/ $^\circ\text{C}$
	Junction temperature	$T_j$		125	$^\circ\text{C}$
Detector	OFF-state output terminal voltage	$V_{OFF}$		30	V
	ON-state current (A connection)	$I_{ON}$	(Note 1)	4.0	A
	ON-state current (B connection)	$I_{ON}$	(Note 1)	4.0	A
	ON-state current (C connection)	$I_{ON}$	(Note 1)	8.0	A
	ON-state current derating (A connection) ( $T_a \geq 25\text{ }^\circ\text{C}$ )	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-40	mA/ $^\circ\text{C}$
	ON-state current derating (B connection) ( $T_a \geq 25\text{ }^\circ\text{C}$ )	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-40	mA/ $^\circ\text{C}$
	ON-state current derating (C connection) ( $T_a \geq 25\text{ }^\circ\text{C}$ )	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-80	mA/ $^\circ\text{C}$
	ON-state current (pulsed) ( $t = 100\text{ ms}$ , Duty = 1/10)	$I_{ONP}$		12	A
	Output power dissipation	$P_O$		400	mW
	Output power dissipation derating ( $T_a \geq 25\text{ }^\circ\text{C}$ )	$\Delta P_O / \Delta T_a$		-4.0	mW/ $^\circ\text{C}$
	Junction temperature	$T_j$		125	$^\circ\text{C}$
Common	Storage temperature	$T_{stg}$		-55 to 125	$^\circ\text{C}$
	Operating temperature	$T_{opr}$		-40 to 85	$^\circ\text{C}$
	Lead soldering temperature (10 s)	$T_{sol}$		260	$^\circ\text{C}$
	Isolation voltage AC, 60 s, R.H. $\leq 60\%$	$BV_S$	(Note 2)	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: For an application circuit example, see Chapter 12.2.

Note 2: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

## 7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Typ.	Max	Unit
Supply voltage	$V_{DD}$		—	—	24	V
Input forward current	$I_F$		5	10	25	mA
ON-state current (A connection)	$I_{ON}$		—	—	4.0	A
Operating temperature	$T_{opr}$		-20	—	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.

## 8. Electrical Characteristics (Unless otherwise specified, $T_a = 25\text{ °C}$ )

	Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
LED	Input forward voltage	$V_F$		$I_F = 10\text{ mA}$	1.18	1.33	1.48	V
	Input reverse current	$I_R$		$V_R = 5\text{ V}$	—	—	10	$\mu\text{A}$
	Input capacitance	$C_t$		$V = 0\text{ V}, f = 1\text{ MHz}$	—	70	—	pF
Detector	OFF-state current	$I_{OFF}$		$V_{OFF} = 30\text{ V}$	—	—	1	$\mu\text{A}$
				$V_{OFF} = 20\text{ V}$	—	—	20	nA
	Output capacitance	$C_{OFF}$		$V = 0\text{ V}, f = 1\text{ MHz}$	—	1100	—	pF

## 9. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25\text{ °C}$ )

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	$I_{FT}$		$I_{ON} = 100\text{ mA}$	—	0.3	3	mA
Return LED current	$I_{FC}$		$I_{OFF} = 10\text{ }\mu\text{A}$	0.1	—	—	
ON-state resistance (A connection)	$R_{ON}$	(Note 1)	$I_{ON} = 4.0\text{ A}, I_F = 5\text{ mA}, t < 1\text{ s}$	—	20	40	m $\Omega$
ON-state resistance (B connection)				—	8	20	
ON-state resistance (C connection)				—	4	10	

Note 1: For an application circuit example, see Chapter 12.2.

## 10. Isolation Characteristics (Unless otherwise specified, $T_a = 25\text{ °C}$ )

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Total capacitance (input to output)	$C_S$	(Note 1)	$V_S = 0\text{ V}, f = 1\text{ MHz}$	—	0.8	—	pF
Isolation resistance	$R_S$	(Note 1)	$V_S = 500\text{ V}, R.H. \leq 60\%$	$5 \times 10^{10}$	$10^{14}$	—	$\Omega$
Isolation voltage	$BV_S$	(Note 1)	AC, 60 s	1500	—	—	Vrms

Note 1: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

## 11. Switching Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$ )

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Turn-on time	$t_{ON}$		See Fig. 11.1. $R_L = 200\ \Omega$ , $V_{DD} = 20\ \text{V}$ , $I_F = 5\ \text{mA}$	—	1.1	5.0	ms
			See Fig. 11.1. $R_L = 200\ \Omega$ , $V_{DD} = 20\ \text{V}$ , $I_F = 10\ \text{mA}$	—	0.6	3.0	
Turn-off time	$t_{OFF}$		See Fig. 11.1. $R_L = 200\ \Omega$ , $V_{DD} = 20\ \text{V}$ , $I_F = 5\ \text{mA}$	—	0.1	1.0	
			See Fig. 11.1. $R_L = 200\ \Omega$ , $V_{DD} = 20\ \text{V}$ , $I_F = 10\ \text{mA}$	—	0.1	1.0	

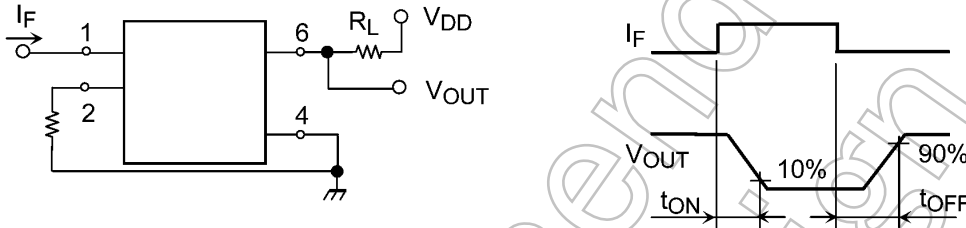


Fig. 11.1 Switching Time Test Circuit and Waveform

Not Recommended for New Design

## 12. Characteristics Curves and Circuit Connections

### 12.1. Characteristics Curves (Note)

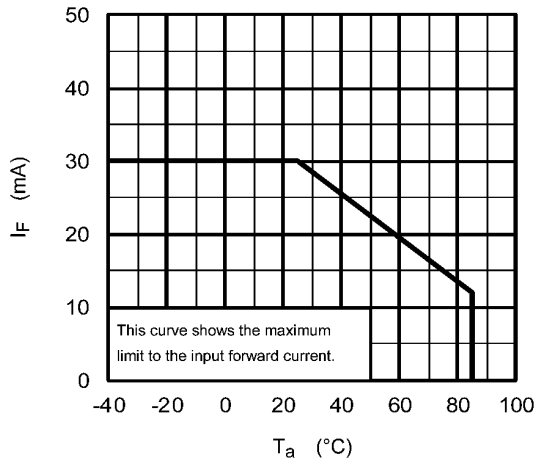


Fig. 12.1.1  $I_F - T_a$

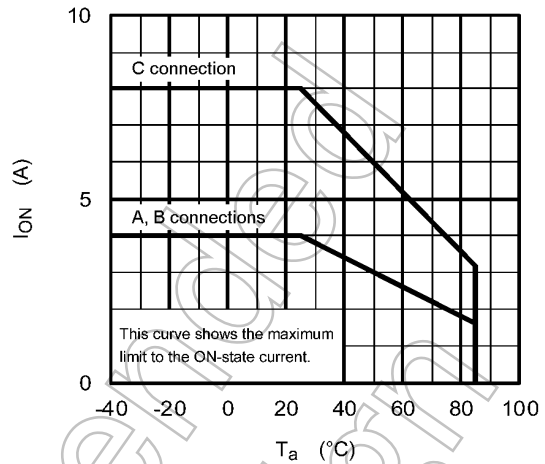


Fig. 12.1.2  $I_{ON} - T_a$

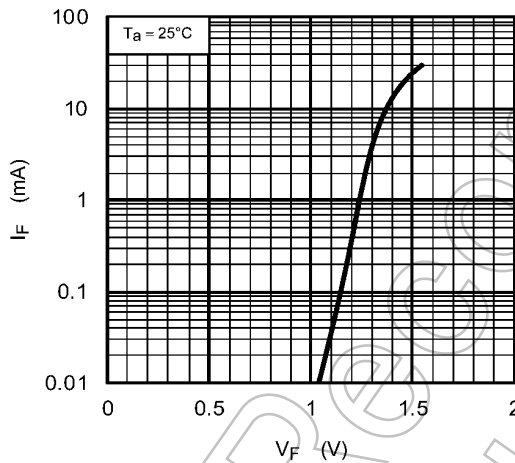


Fig. 12.1.3  $I_F - V_F$

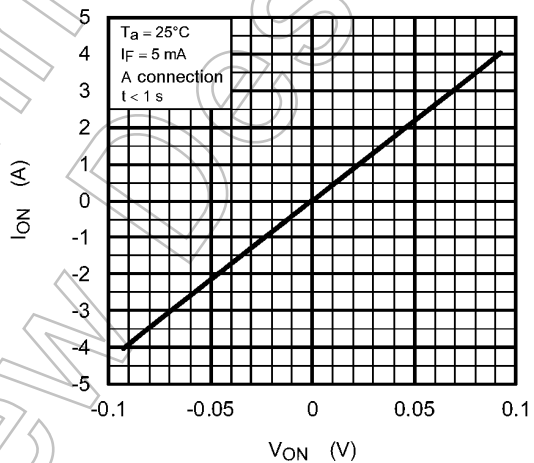


Fig. 12.1.4  $I_{ON} - V_{ON}$

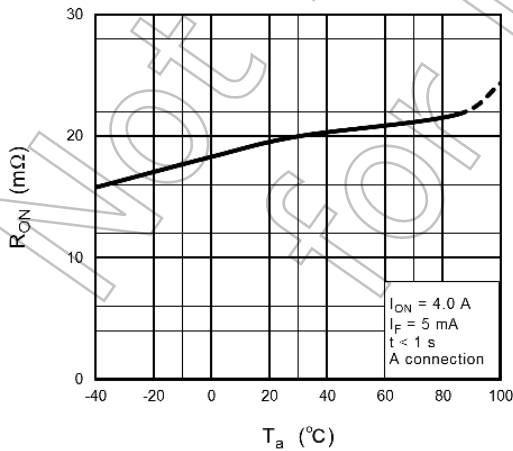


Fig. 12.1.5  $R_{ON} - T_a$

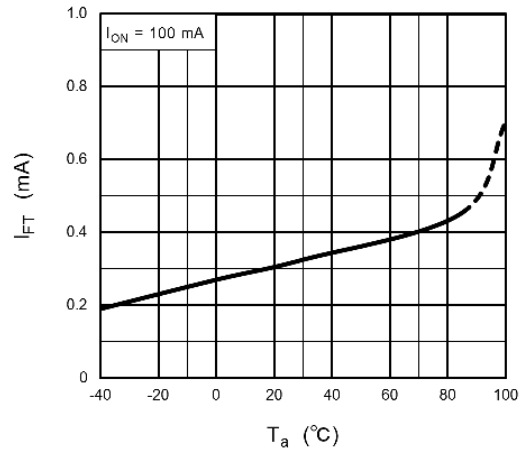


Fig. 12.1.6  $I_{FT} - T_a$

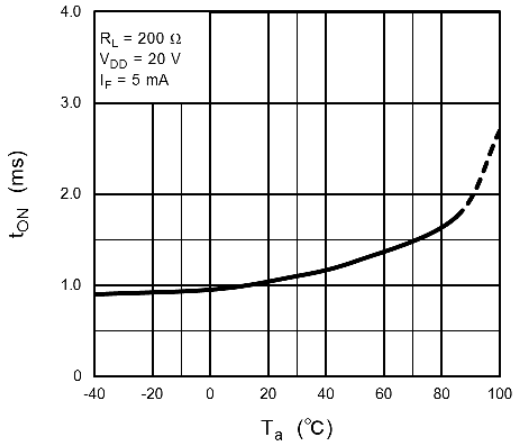


Fig. 12.1.7  $t_{ON} - T_a$

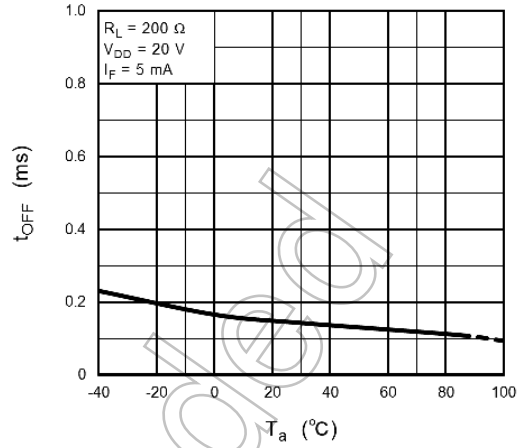


Fig. 12.1.8  $t_{OFF} - T_a$

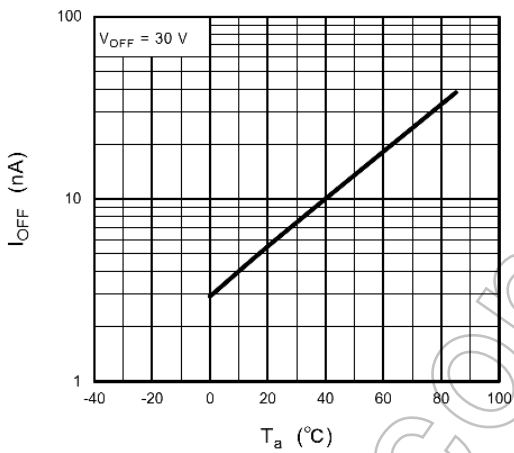
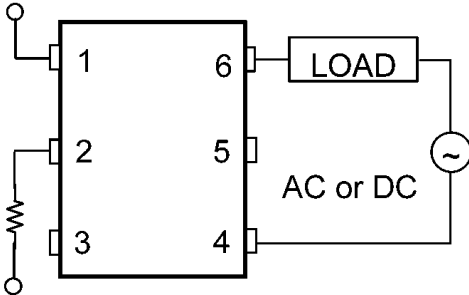


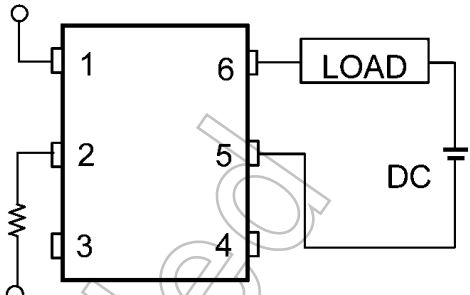
Fig. 12.1.9  $I_{OFF} - T_a$

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

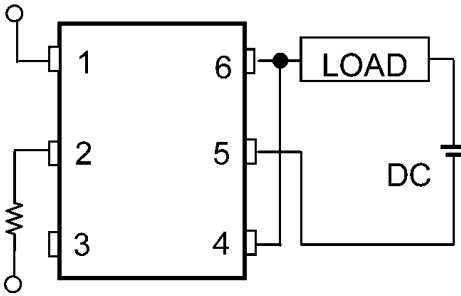
**12.2. Circuit Connections**



**Fig. 12.2.1 A Connection**



**Fig. 12.2.2 B Connection**

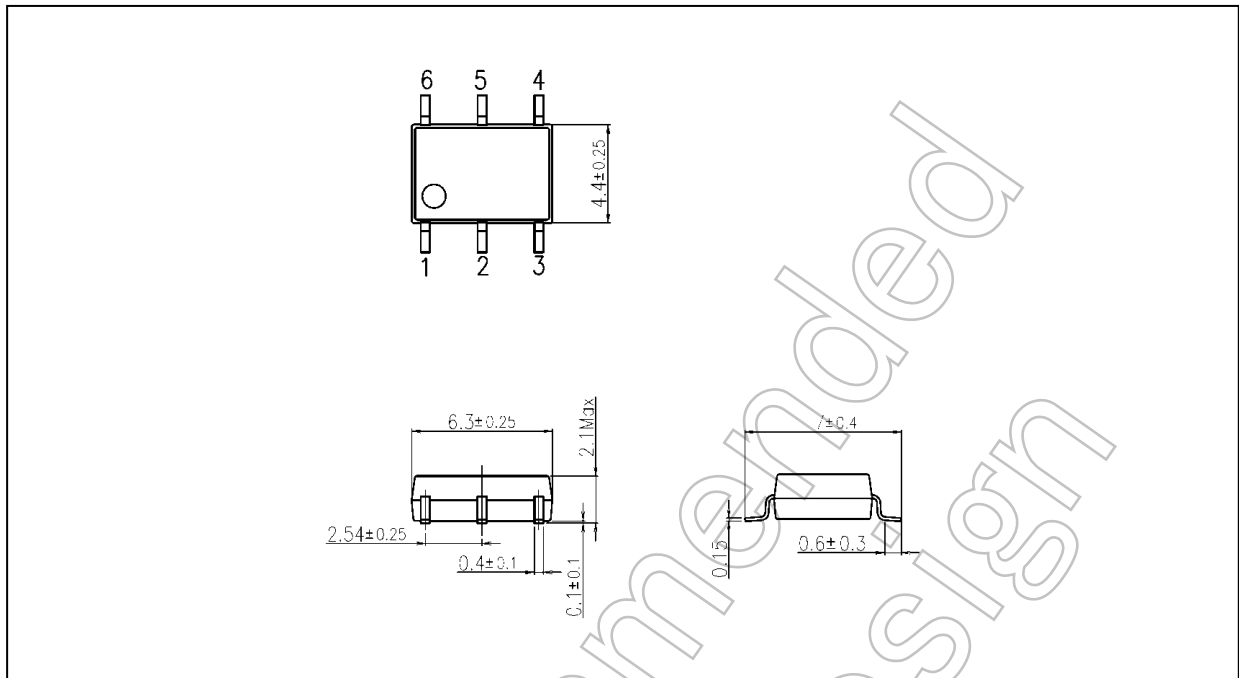


**Fig. 12.2.3 C Connection**

Not Recommended for New Design

## Package Dimensions

Unit: mm



Weight: 0.13 g (typ.)

Package Name(s)
TOSHIBA: 11-7C1S

Not Recommended for New Design



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